

# Willkommen bei o-führend

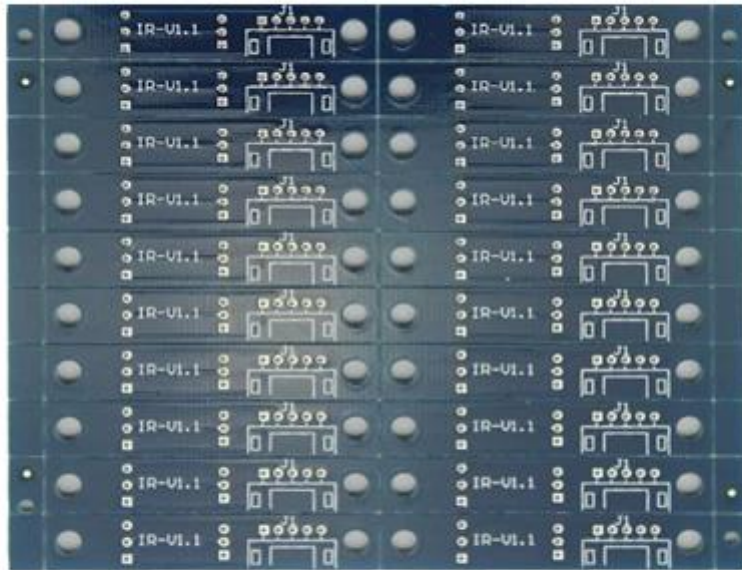
O-Lead ist einst bemüht, Ihr One-Stop-Lösungspartner in der EMS-Lieferkette zu sein, einschließlich PCB-Design, PCB-Fabrikation und PCB-Baugruppe (PCBA). Wir bieten einigen der fortschrittlichsten PCB-Technologie, einschließlich HDI-Leiterplatten, mehrschichtige Leiterplatten, steif-flexible PCBs Wir können von einem schnellen Turn-Prototyp zur mittleren & Massenproduktion unterstützen.

Im Allgemeinen sind unsere globalen Kunden sehr beeindruckt von unseren Diensten: Schnelle Reaktion, wettbewerbsfähiger Preise und Qualitätszusagen. Provovieren mehr wertvoller technischer Service und allgemeine Lösung ist der Weg, der nach vorne führt.

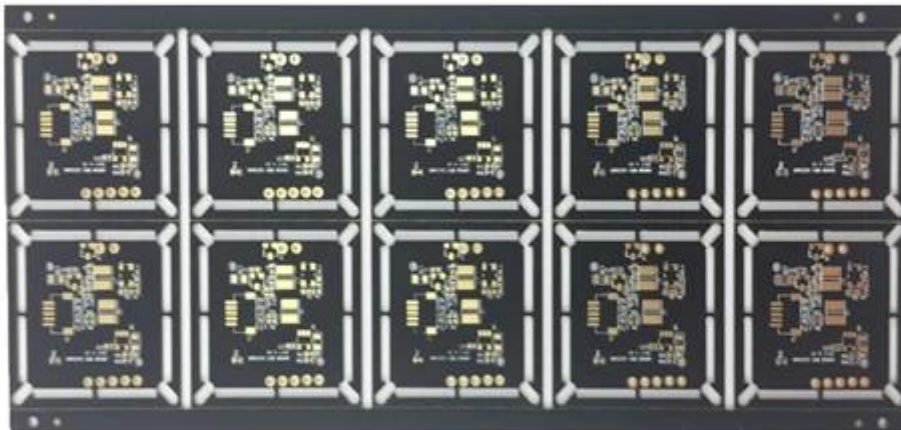
Wenn Sie auf die Zukunft suchen, konzentriert sich o-führend auf die Innovation und Entwicklung der Elektronikfertigungstechnologie sowie anhaltende Anstrengungen für den PCB- und PCBA-One-Stop-Service, um erstklassige Dienste bereitzustellen und für unsere Kunden mehr Wert zu schaffen.

Bitte klicken Sie auf diese, um weitere Informationen zu erhalten: [Leiterplatte in China](#), [Multilayer-PCB-Hersteller in China](#), [Doppelseitiger PCB-Hersteller China](#)

Herkunftsort	Guangdong China (Festland)	Markenname	O-führend
Basismaterial	FR-4, Aluminium	Kupferdicke.	0,5z-5oz.
Mindest. Lochgröße	0,2 mm	Mindest. Linienbreite	0,2 mm
Oberflächenveredelung.	Immersiongold, OSP, Bleifrei HASL	Boarddicke.	0,1-5 mm
anwendbar auf	LED, Mobiltelefon, Klimaanlage, Waschmaschinen	Charakter	Industrielle Steuerung PCB.
Zertifikate	ISO9001, UL, ROHS, SGS	Q / ctn.	10pcs-100pcs.
Gewicht	0,01 kg -5kg.	Moq.	10pcs.
Farbe	blau, rot, grün, schwarz.	Mindest. Zeilenabstand	0,2 mm
Modell Taub.E.R.	Power Bank PCB-Baugruppe PCBA-Hersteller	Preis	\$ 0,1- \$ 10
Desique-Typ.	Kundenanforderung.	S.Ize	0,01 m-10m3.



[www.o-leading.com](http://www.o-leading.com)



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Unser Team





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Factory PCB

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Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

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Factory SMT

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# Zertifizierungen

CICC INSPECTION CERTIFICATION



**嘉泰认证**

**QUALITY MANAGEMENT SYSTEM CERTIFICATE**

Certificate No: 18118Q10347R05

**We hereby certify that**

**O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED**

Credit No: 61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VODEUS ROAD CENTRAL HK

Business Add: 1213, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System** Which fulfills the requirements of the following standards  
GB/T19001-2016 idt ISO9001:2015

**Scope of certification**  
Sales of printed circuit boards

Initial issuance period: February 27, 2018  
Renewal date: April 22, 2019  
This certificate is valid during: April 22, 2019 – February 26, 2021  
This certificate is invalid without CICC qualified label in the following period

First supervision and audit	Second supervision and audit	Qualified mark
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The certification registration number does not include those production stages which fail to be covered by the relevant effective administrative procedures and qualification procedures stipulated by the client. The effectiveness of this certificate shall be restricted to actual certification scope of CICC. The certificate shall be valid when used together with the qualified mark issued.

The initial issuance of this certification can be searched on the portal of CICC [www.cicc.com.cn](http://www.cicc.com.cn) by the code of inquiry [www.cicc.com.cn](http://www.cicc.com.cn).






CICC INSPECTION CERTIFICATION



**嘉泰认证**

**质量管理体系认证证书**

证书号: 18118Q10347R05

**兹证明**

**诚领供应链(香港)有限公司**

统一社会信用代码: 61691591-000-07-18-7

注册地址: 香港中環德輔道中130-132號大生銀行大廈1205室

经营地址: 广东惠州惠阳淡水南亨西路财富大厦13楼1313

**建立的质量管理体系符合**  
GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

**认证范围**  
印刷线路板的销售

初次获证日期: 2018年02月27日  
换证日期: 2019年04月22日  
证书有效期: 自2019年04月22日至2021年02月26日  
在下列期限内, 未经CICC黏贴合格标贴, 本证书无效

第一次监督	第二次监督	黏贴处
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Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ
Date of Sample Received : 22 Mar 2019
Testing Period : 22 Mar 2019 - 30 Mar 2019
Test Requested : Selected test(s) as requested by client.
Test Method : Please refer to next page(s).
Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina
Tina Fan
Approved Signatory



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Test Report

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Test Results :

Test Part Description :

Table with 3 columns: Specimen No., SGS Sample ID, Description. Row 1: SN1, SZX19-005304.001, Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit
(3) ND = Not Detected (< MDL)
(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Table with 5 columns: Test Item(s), Limit, Unit, MDL, 0/1. Lists various substances like Cadmium, Lead, Mercury, Hexavalent Chromium, Sum of PBBs, etc.



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# ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

## Wiring, Printed - Component

See General Information for Wiring, Printed - Component

**O-LEADING SUPPLY CHAIN (HK) CO LTD**  
 ROOM 1205, 12/F  
 TAI SANG BANK BLDG  
 130-132 DES VOEUS ROAD  
 CENTRAL, HONG KONG

E490354

Type	Cond Width		Cond Thk	SS/ DS/ DSO	Max	Max		Meets	C		
	Min	Edge			Area	Solder	Oper			Flame	
	mm(in)	mm(in)	mic(mil)		Diam	Limits	Temp	Class	UL796	T	
<b>Multilayer (mass laminate) printed wiring boards.</b>											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	
<b>Multilayer printed wiring boards.</b>											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
<b>Single layer printed wiring boards.</b>											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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## Shipping service





Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

## Prozessfähigkeit

### PCB-Produktionsfunktionen

Layer Count: 1LAYER-32LAYER

Fertigkupferdicke: 1 / 3Oz-12Oz

Min Linienbreite / Abstand intern: 3.0mil / 3,0mil

Min Linie Breite / Abstand External: 4.0mil / 4.0mil

Max-Seitenverhältnis: 10: 1

Boarddicke: 0,2 mm-5,0 mm

Max-Panel-Größe (Zoll): 635 \* 1500mm

Minimum Bohrlochgröße: 4mil

Platt-Lochtoleranz: +/- 3mil

Blind / begrabene Vias (All-Typen): Ja

Via Fill (leitfähig, nicht leitend): Ja

Basismaterial: FR-4, FR-4HIGH TG.halogenfreies Material, Rogers, Aluminiumbasis,Polyimid,

Schweres Kupfer

Oberflächenoberflächen: HASL, OSP, Riesen-, Hal-LF, Linssion Silber,Linssion Zinn, Goldfinger,

Kohlenstofffarbe

## **SMT-Produktionsfunktionen**

PCB-Material: FR-4, CEM-1, CEM-3, Bord von Aluminiumbasis

MAX PCB Größe: 510x460mm

MIN Leiterplattengröße: 50x50mm

PCB-Dicke: 0,5 mm-4,5 mm

Boarddicke: 0,5-4 mm

MIN-Komponenten Größe: 0201

Standard-Chipgröße-Komponente: 0603 und größer

Component max Height: 15mm

Min-Lead-Pitch: 0,3 mm

Min BGA Ball Pitch: 0,4 mm

Platzierung Präzision: +/- 0,03 mm